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Vishay/Siliconix SIA438EDJ-T1-GE3

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Datasheet of SIA438EDJ-T1-GE3 - MOSFET N-CH 20V 6A PPAK SC70-6L

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#### **New Product**

### SiA438EDJ

HALOGEN

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## N-Channel 20-V (D-S) MOSFET

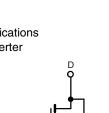
PRODUCT SUMMARY					
V <sub>DS</sub> (V)	$R_{DS(on)}\left(\Omega\right)$	I <sub>D</sub> (A) <sup>a</sup>	Q <sub>g</sub> (Typ.)		
20	0.046 at V <sub>GS</sub> = 4.5 V	6	3.5 nC		
	$0.063 \text{ at V}_{GS} = 2.5 \text{ V}$	6	3.5110		

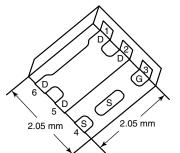
#### **FEATURES**

- Halogen-free According to IEC 61249-2-21
- TrenchFET® Power MOSFET
- New Thermally Enhanced PowerPAK® SC-70 Package
  - Small Footprint Area
  - Low On-Resistance
- Typical ESD Protection 1200 V

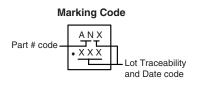
#### **APPLICATIONS**

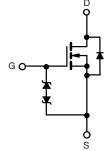
- Load Switch for Portable Applications
- High Frequency DC/DC Converter





PowerPAK SC-70-6L-Single





Ordering Information: SiA438EDJ-T1-GE3 (Lead (Pb)-free and Halogen-free)

N-Channel MOSFET

Parameter		Symbol	Limit	Unit	
Drain-Source Voltage		V <sub>DS</sub>	20	V	
Gate-Source Voltage		$V_{GS}$	± 12	•	
Continuous Drain Current (T <sub>J</sub> = 150 °C)	T <sub>C</sub> = 25 °C T <sub>C</sub> = 70 °C	_	6 <sup>a</sup> 6 <sup>a</sup>		
	T <sub>A</sub> = 25 °C T <sub>A</sub> = 70 °C	I <sub>D</sub>	5.7 <sup>b, c</sup> 4.5 <sup>b, c</sup>	Α	
Pulsed Drain Current		I <sub>DM</sub>	15		
Continuous Source-Drain Diode Current	T <sub>C</sub> = 25 °C T <sub>A</sub> = 25 °C	Is	6 <sup>a</sup> 1.75 <sup>b, c</sup>	$\blacksquare$	
Maximum Power Dissipation	$T_{C} = 25 ^{\circ}\text{C}$ $T_{C} = 70 ^{\circ}\text{C}$ $T_{A} = 25 ^{\circ}\text{C}$ $T_{A} = 70 ^{\circ}\text{C}$	P <sub>D</sub>	11.4 7.3 2.4 <sup>b, c</sup> 1.5 <sup>b, c</sup>	w	
Operating Junction and Storage Temperature Range		T <sub>J</sub> , T <sub>stg</sub> - 55 to 150		°C	
Soldering Recommendations (Peak Temperature) <sup>d, e</sup>			260		

THERMAL RESISTANCE RATINGS						
Parameter		Symbol Typical		Maximum	Unit	
Maximum Junction-to-Ambient <sup>b, f</sup>	t ≤ 5 s	R <sub>thJA</sub>	41	52	°C/W	
Maximum Junction-to-Case (Drain)	Steady State	$R_{thJC}$	9	11	]	

#### Notes:

- a. Package limited
- b. Surface Mounted on 1" x 1" FR4 board.
- d. See Solder Profile (www.vishay.com/ppg?73257). The PowerPAK SC-70 is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection.
- e. Rework Conditions: manual soldering with a soldering iron is not recommended for leadless components.
- f. Maximum under Steady State conditions is 90 °C/W.

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Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static	-		I.		•	•	
Drain-Source Breakdown Voltage	V <sub>DS</sub>	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$	20			V	
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$			23		1105	
V <sub>GS(th)</sub> Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	I <sub>D</sub> = 250 μA		- 3.3		mV/°C	
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}$ , $I_{D} = 250 \mu A$	0.6		1.4	٧	
Gate-Source Leakage	I <sub>GSS</sub>	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 12 \text{ V}$			± 70	- μΑ	
		$V_{DS} = 0 \text{ V}, V_{GS} = \pm 4.5 \text{ V}$			± 1		
Zero Gate Voltage Drain Current	_	V <sub>DS</sub> = 20 V, V <sub>GS</sub> = 0 V			- 1		
	I <sub>DSS</sub>	V <sub>DS</sub> = 20 V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 55 °C			- 10		
On-State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} \ge 5 \text{ V}, V_{GS} = 4.5 \text{ V}$	10			Α	
	R <sub>DS(on)</sub>	V <sub>GS</sub> = 4.5 V, I <sub>D</sub> = 3.9 A		0.037	0.046	Ω	
Drain-Source On-State Resistance <sup>a</sup>		V <sub>GS</sub> = 2.5 V, I <sub>D</sub> = 3.3 A		0.051	0.063		
Forward Transconductance <sup>a</sup>	9 <sub>fs</sub>	V <sub>DS</sub> = 10 V, I <sub>D</sub> = 3.9 A		14		S	
Dynamic <sup>b</sup>				<u> </u>	1		
Input Capacitance	C <sub>iss</sub>			350			
Output Capacitance	C <sub>oss</sub>	V <sub>DS</sub> = 10 V, V <sub>GS</sub> = 0 V, f = 1 MHz		63		pF	
Reverse Transfer Capacitance	C <sub>rss</sub>	30 7 GO 7		37			
Tieveree manerer expansion	- 155	V <sub>DS</sub> = 10 V, V <sub>GS</sub> = 10 V, I <sub>D</sub> = 5.1 A		7.5	12	nC	
Total Gate Charge	$Q_g$	103 10 1, 103 10 1, 10 01111		3.5	5.5		
Gate-Source Charge	Q <sub>gs</sub>	$V_{DS} = 10 \text{ V}, V_{GS} = 4.5 \text{ V}, I_{D} = 5.1 \text{ A}$		0.95			
Gate-Drain Charge	Q <sub>gd</sub>			0.75			
Gate Resistance	R <sub>g</sub>	f = 1 MHz		3.5		Ω	
Turn-On Delay Time	t <sub>d(on)</sub>			10	15		
Rise Time	t <sub>r</sub>			12	20	ns	
Turn-Off Delay Time	t <sub>d(off)</sub>	$V_{DD} = 10 \text{ V}, R_L = 2.4 \Omega$		18	30		
Fall Time	t <sub>f</sub>	$I_D \cong 4.1 \text{ A}, V_{GEN} = 4.5 \text{ V}, R_g = 1 \Omega$		12	20		
Turn-On Delay Time	t <sub>d(on)</sub>			5	10		
Rise Time	t <sub>r</sub>			12	20		
Turn-Off Delay Time	t <sub>d(off)</sub>	$V_{DD} = 10 \text{ V}, R_L = 2.4 \Omega$		15	25		
Fall Time	t <sub>f</sub>	$I_D \cong 4.1 \text{ A}, V_{GEN} = 10 \text{ V}, R_g = 1 \Omega$		10	15		
Drain-Source Body Diode Characteristic	l						
Continuous Source-Drain Diode Current	I <sub>S</sub>	T <sub>C</sub> = 25 °C			6	_	
Pulse Diode Forward Current	I <sub>SM</sub>	-			15	A	
Body Diode Voltage	V <sub>SD</sub>	I <sub>S</sub> = 4.1 A, V <sub>GS</sub> = 0 V		0.8	1.2	V	
Body Diode Reverse Recovery Time	t <sub>rr</sub>	5 55		15	30	ns	
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>	I <sub>F</sub> = 4.1 A, dl/dt = 100 A/μs, T <sub>J</sub> = 25 °C		8	20	nC	
Reverse Recovery Fall Time	t <sub>a</sub>			8			
Reverse Recovery Rise Time	t <sub>b</sub>			7		ns	

- a. Pulse test; pulse width  $\leq$  300  $\mu s,$  duty cycle  $\leq$  2 %
- b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

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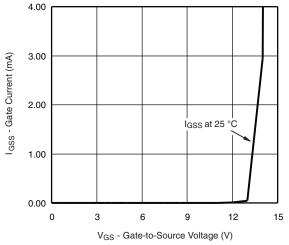
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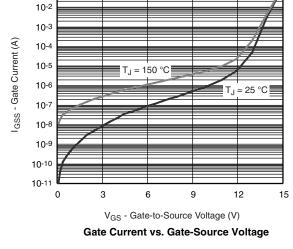
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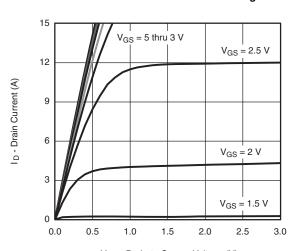
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#### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

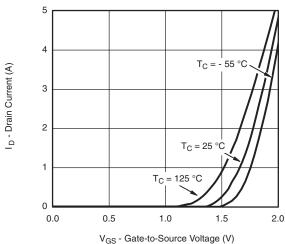


#### Gate Current vs. Gate-Source Voltage

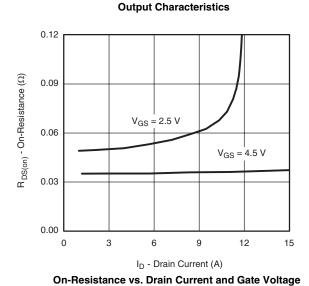




V<sub>DS</sub> - Drain-to-Source Voltage (V)



**Transfer Characteristics** 



C - Capacitance (pF) 100 2 4 6 12 0 10 14

Ciss

500

400

300

200

V<sub>DS</sub> - Drain-to-Source Voltage (V) Capacitance

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1.7

 $I_{D} = 3.9 \text{ A}$ 

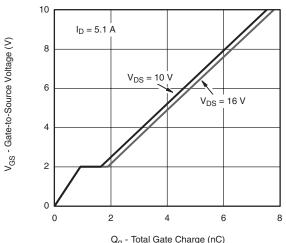
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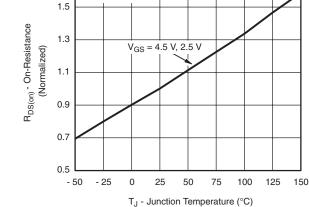
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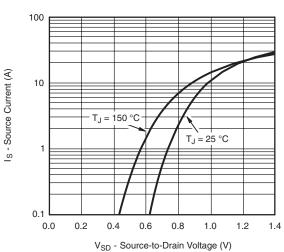
#### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



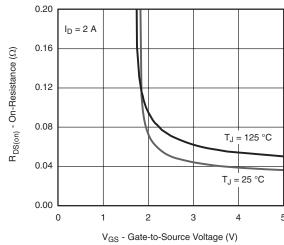
 $\mathbf{Q}_g$  - Total Gate Charge (nC)  $\label{eq:Gate Charge} \textbf{Gate Charge}$ 



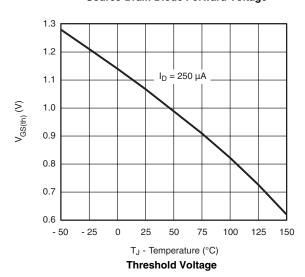
On-Resistance vs. Junction Temperature

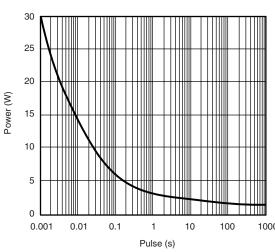


Source-Drain Diode Forward Voltage



On-Resistance vs. Gate-to-Source Voltage





Single Pulse Power (Junction-to-Ambient)

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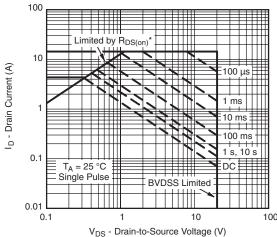
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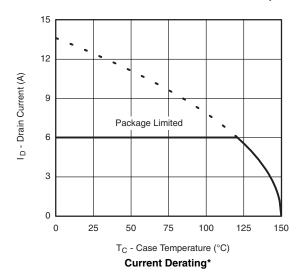
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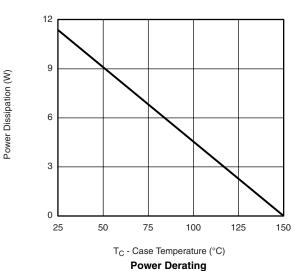
#### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



\*  $V_{GS}$  > minimum  $V_{GS}$  at which  $R_{DS(on)}$  is specified

#### Safe Operating Area, Junction-to-Ambient





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 $<sup>^{\</sup>star}$  The power dissipation P<sub>D</sub> is based on T<sub>J(max)</sub> = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package

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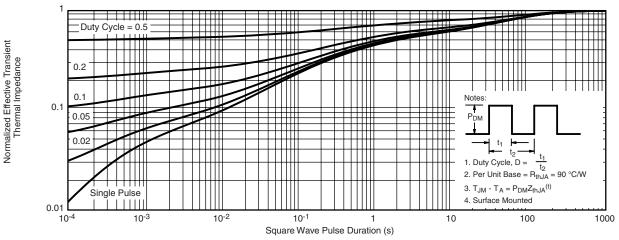
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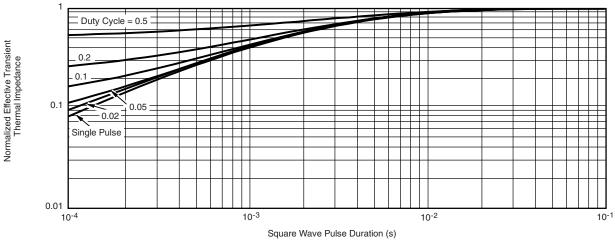
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#### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Case

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see <a href="https://www.vishay.com/ppg?69092">www.vishay.com/ppg?69092</a>.



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